

Intelligent Power Module (IPM) 650 V, 30 A

NFAM3065L4BTL

General Description

The NFAM3065L4BTL is a fully-integrated inverter power module consisting of an independent High side gate driver, LVIC, six IGBT's and a temperature sensor (VTS or Thermistor (T)), suitable for driving permanent magnet synchronous (PMSM) motors, brushless DC (BLDC) motors and AC asynchronous motors. The IGBT's are configured in a three-phase bridge with separate emitter connections for the lower legs for maximum flexibility in the choice of control algorithm.

The power stage has undervoltage lockout protection (UVP). Internal boost diodes are provided for high side gate boost drive.

Features

- Three-phase 650 V, 30 A IGBT Module with Independent Drivers
- Active Logic Interface
- Built-in Undervoltage Protection (UVP)
- Integrated Bootstrap Diodes and Resistors
- Separate Low-side IGBT Emitter Connections for Individual Current Sensing of Each Phase
- Temperature Sensor (VTS or Thermistor (T))
- UL1557 Certified (File No.339285)
- This Device is Pb-Free and RoHS Compliant

Typical Applications

- Industrial Drives
- Industrial Pumps
- Industrial Fans
- Industrial Automation

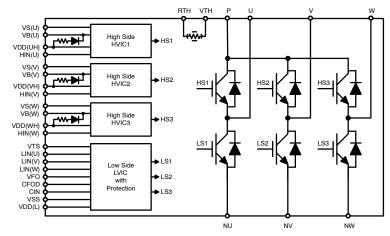
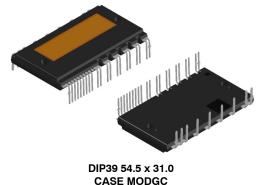


Figure 1. Application Schematic

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MARKING DIAGRAM

O NFAM3065L4BTL O ZZZATYWW

Device marking is on package top side

NFAM3065L4BTL = Specific Device Code
ZZZ = Assembly Lot Code
A = Assembly Location
T = Test Location
Y = Year
WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
NFAM3065L4BTL	DIP39	90 / Box
	54.5 x 31.0	
	(Pb-Free)	

APPLICATION SCHEMATIC

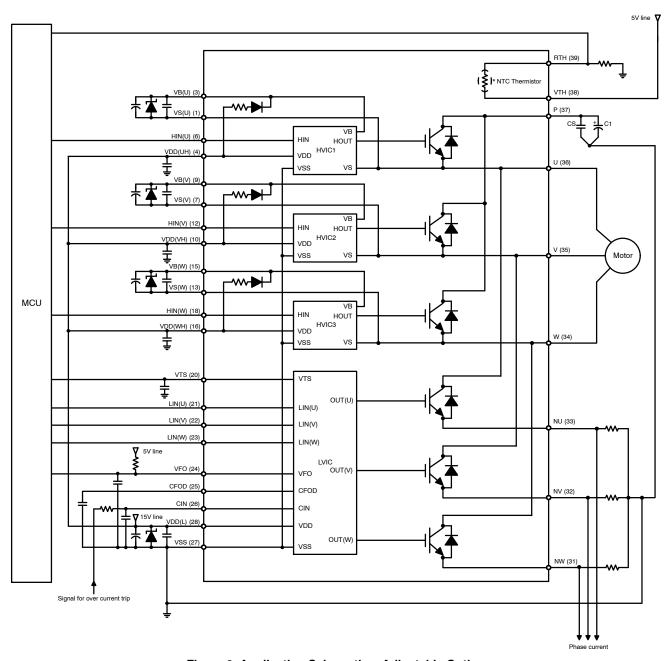


Figure 2. Application Schematic - Adjustable Option

BLOCK DIAGRAM

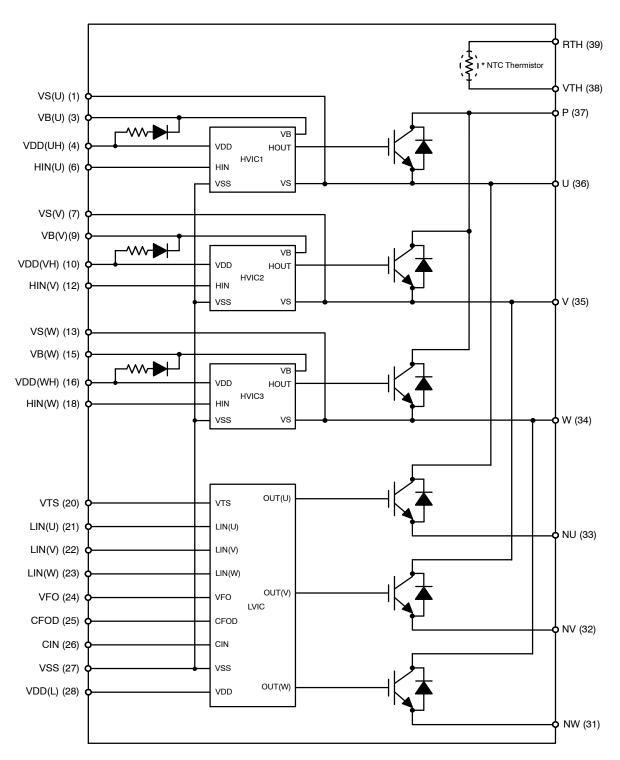


Figure 3. Equivalent Block Diagram

PIN FUNCTION DESCRIPTION

Pin	Name	Description
1	VS(U)	High-Side Bias Voltage GND for U phase IGBT Driving
(2)	-	Dummy
3	VB(U)	High-Side Bias Voltage for U phase IGBT Driving
4	VDD(UH)	High-Side Bias Voltage for U phase IC
(5)	-	Dummy
6	HIN(U)	Signal Input for High-Side U Phase
7	VS(V)	High-Side Bias Voltage GND for V phase IGBT Driving
(8)	-	Dummy
9	VB(V)	High-Side Bias Voltage for V phase IGBT Driving
10	VDD(VH)	High-Side Bias Voltage for V phase IC
(11)	-	Dummy
12	HIN(V)	Signal Input for High-Side V Phase
13	VS(W)	High-Side Bias Voltage GND for W phase IGBT Driving
(14)	-	Dummy
15	VB(W)	High-Side Bias Voltage for W phase IGBT Driving
16	VDD(WH)	High-Side Bias Voltage for W phase IC
(17)	-	Dummy
18	HIN(W)	Signal Input for High-Side W Phase
(19)	-	Dummy
20	VTS	Voltage Output for LVIC Temperature Sensing Unit
21	LIN(U)	Signal Input for Low-Side U Phase
22	LIN(V)	Signal Input for Low-Side V Phase
23	LIN(W)	Signal Input for Low-Side W Phase
24	VFO	Fault Output
25	CFOD	Capacitor for Fault Output Duration Selection
26	CIN	Input for Current Protection
27	VSS	Low-Side Common Supply Ground
28	VDD(L)	Low-Side Bias Voltage for IC and IGBTs Driving
(29)	-	Dummy
(30)	-	Dummy
31	NW	Negative DC-Link Input for U Phase
32	NV	Negative DC-Link Input for V Phase
33	NU	Negative DC-Link Input for W Phase
34	W	Output for U Phase
35	V	Output for V Phase
36	U	Output for W Phase
37	Р	Positive DC-Link Input
38	VTH	Thermistor Bias Voltage (T) / Not connection
39	RTH	Series Resister for Thermistor (Temperature Detection) *optional for T

Pins of () are the dummy for internal connection. These pins should be no connection.

ABSOLUTE MAXIMUM RATINGS ($T_C = 25^{\circ}C$) (Note 2)

Symbol	Rating	Conditions	Value	Unit
VPN	Supply Voltage	P-NU, NV, NW	450	V
VPN(surge) Supply Voltage (Surge) P-		P-NU, NV, NW (Note 3)	550	V
VPN(PROT)	Self Protection Supply Voltage Limit (Short-Circuit Protection Capability)	VDD = VBS = 13.5 V to 16.5 V, Tj = 150°C, VCES < 650 V, Non-Repetitive, < 2 μs	400	V
Vces	Collector-emitter Voltage		650	V
VRRM	Maximum Repetitive Revers Voltage		650	V
±lc	Each IGBT Collector Current		±30	Α
±lcp	Each IGBT Collector Current (Peak)	Under 1ms Pulse Width	±60	Α
VDD	Control Supply Voltage	VDD(UH,VH,WH), VDD(L)-VSS	-0.3 to 20	V
VBS	High-Side Control Bias voltage	VB(U)-VS(U), VB(V)-VS(V), VB(W)-VS(W)	-0.3 to 20	V
VIN	Input Signal Voltage	HIN(U), HIN(V), HIN(W), LIN(U), LIN(V), LIN(W)-VSS	-0.3 to VDD	V
VFO	Fault Output Supply Voltage	VFO-VSS	-0.3 to VDD	V
IFO	Fault Output Current	Sink Current at VFO pin	2	mA
VCIN	Current Sensing Input Voltage	CIN-VSS	-0.3 to VDD	V
Pc	Corrector Dissipation	Per One Chip	113	W
Tj	Operating Junction Temperature		-40 to +150	°C
Tstg	Storage Temperature		-40 to +125	°C
Tc	Module Case Operation Temperature		-40 to +125	°C
Viso	Isolation Voltage	60 Hz, Sinusoidal, AC 1 minute, Connection Pins to Heat Sink Plate	2500	V rms

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

2. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe

THERMAL CHARACTERISTICS

Symbol	Rating	Conditions	Min	Тур	Max	Unit
R _{th(j-c)Q}	Junction-to-Case Thermal Resistance	Inverter IGBT Part (per 1/6 module)	-	-	1.1	°C/W
R _{th(j-c)F}	Resistance	Inverter FWD Part (per 1/6 module)	=	-	2.2	°C/W

^{4.} Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe Operating parameters.

Operating parameters.

^{3.} This surge voltage developed by the switching operation due to the wiring inductance between P and NU, NV, NW terminal.

RECOMMENDED OPERATING CONDITIONS

Symbol	Rating	Conditions		Min	Тур	Max	Unit
VPN	Supply Voltage	P-NU, NV, NW		-	300	400	V
VDD	Gate Driver Supply	VDD(UH,VH,WH),	, VDD(L)-VSS	13.5	15	16.5	V
VBS	Voltages	VB(U)-VS(U), VB(VB(W)-VS(W)	VB(U)-VS(U), VB(V)-VS(V), VB(W)-VS(W)		15	18.5	V
dVDD / dt, dVBS / dt	Supply Voltage Variation				-	1	V/μs
f _{PWM}	PWM Frequency			1	-	20	kHz
DT	Dead Time	Turn-off to Turn-on (external)		1.5	-	-	μs
lo	Allowable r.m.s. Current	VPN = 300 V, VDD = 15 V, P.F. = 0.8	f _{PWM} = 5 kHz	-	-	21.2	A rms
		Tc ≤ 125°C, Tj ≤ 150°C (Note 5)	f _{PWM} = 15 kHz	-	-	17.2	
PWIN (on)	Allowable Input Pulse Width	200 V ≤ VPN ≤ 400 V 13.5 V ≤ VDD ≤ 16.5 V 13.0 V ≤ VBS ≤ 18.5 V -20°C ≤ Tc ≤ 100°C		1.0	-	-	μs
PWIN (off)				1.5	-	_	
	Package Mounting Torque	M3 type screw		0.6	0.7	0.9	Nm

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

5. Allowable r.m.s current depends on the actual conditions.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$, VDD = 15 V, VBS = 15 V, unless otherwise specified.) (Note 7)

Symbol	Paramet	er	Test Conditions	Min	Тур	Max	Unit	
INVERTER SE	CTION							
Ices	Collector-Emitter L	eakage	Vce = Vces, Tj = 25°C	-	-	1	mA	
	Current	Vce = Vces, Tj = 150°C	-	-	10	mA		
VCE(sat)	VCE(sat) Collector-Emitter Saturation Voltage VF FWDi Forward Voltage	aturation	VDD = VBS = 15 V, IN = 5 V Ic = 30 A, Tj = 25°C	-	1.60	2.30	V	
			VDD = VBS = 15 V, IN = 5 V Ic = 30 A, Tj = 150°C	-	1.80	-	V	
VF		age	IN = 0 V, Ic = 30 A, Tj = 25°C	-	2.00	2.40	V	
			IN = 0 V, Ic = 30 A, Tj = 150°C	-	2.00	-	V	
ton	Switching Times	High Side	gh Side	1.00	1.60	2.20	μs	
tc(on)				-	0.50	1.00	μs	
toff				-	1.60	2.20	μs	
tc(off)					-	0.25	0.75	μs
trr				-	0.15	-	μs	
ton		Low Side	VPN = 300 V, VDD(H) = VDD(L) = 15 V	1.10	1.70	2.30	μs	
tc(on)			Ic = 30 A, Tj = 25°C, IN = 0 ⇔ 5 V Inductive Load	_	0.50	1.00	μs	
toff	7			-	1.60	2.20	μs	
tc(off)	7			-	0.25	0.75	μs	
trr				-	0.15	_	μs	

^{6.} Flatness tolerance of the heatsink should be within –50 μ m to +100 μ m.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$, VDD = 15 V, VBS = 15 V, unless otherwise specified.) (Note 7) (continued)

Symbol	Parameter	Test Condit	ions	Min	Тур	Max	Unit
RIVER SECT	TION						
IQDDH	Quiescent VDD Supply Current	VDD(UH,VH,WH) = 15 V, HIN(U,V,W) = 0 V	VDD(UH)-VSS VDD(VH)-VSS VDD(WH)-VSS	-	-	0.30	mA
IQDDL		VDD(L) = 15 V, LIN(U,V,W) = 0 V	VDD(L)-VSS	-	-	3.50	mA
IPDDH	Operating VCC Supply Current	VDD(UH,VH,WH) = 15 V, f _{PWM} = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for High-Side	VDD(UH)-VSS VDD(VH)-VSS VDD(WH)-VSS	-	-	0.40	mA
IPDDL		VDD(L) = 15 V, f _{PWM} = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for Low-Side	VDD(L)-VSS	-	-	6.00	mA
IQBS	Quiescent VBS Supply Current	VBS = 15 V, HIN(U,V,W) = 0 V	VB(U)-VS(U) VB(V)-VS(V) VB(W)-VS(W)	-	-	0.30	mA
IPBS	Operating VBS Supply Current	VDD = VBS = 15 V, f _{PWM} = 20 kHz, Duty = 50%, Applied to one PWM Signal Input for High-Side	VB(U)-VS(U) VB(V)-VS(V) VB(W)-VS(W)	-	-	5.00	mA
VIN(ON)	ON Threshold Voltage	HIN(U,V,W)-VSS, LIN(U,V,V	N)-VSS	_	-	2.6	V
VIN(OFF)	OFF Threshold Voltage			0.8	-	-	V
VCS(ref)	Short Circuit Trip Level	VDD = 15 V, CIN-VSS		0.46	0.48	0.50	V
UVDDD	Supply Circuit	Detection Level		10.3	-	12.5	V
UVDDR	Under-Voltage Protection	Reset Level		10.8	-	13.0	V
UVBSD	1	Detection Level		10.0	-	12.0	V
UVBSR	1	Reset Level		10.5	-	12.5	V
VTS	Voltage Output for LVIC Temperature Sensing Unit	VTS-VSS = 10 nF, Temp. =	25°C	0.905	1.030	1.155	V
VFOH	Fault Output Voltage	$VDD = 0 V$, $CIN = 0 V$, VFO Circuit: $10 k\Omega$ to $5 V$ Pull-up		4.9	-	_	V
VFOL		VDD = 0 V, CIN = 1 V, VFO Circuit: 10 k Ω to 5 V Pull-up		-	-	0.95	V
t _{FOD}	Fault-Output Pulse Width	CFOD = 22 nF		1.6	2.4	-	ms
OOTSTRAP	SECTION						
VF	Bootstrap Diode Forward Voltage	If = 0.1 A		3.4	4.6	5.8	V
RBOOT	Built-in Limiting Resistance			30	38	46	Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{7.} Performance guaranteed over the indicated operating temperature range by design and/or characterization tested at T_J = T_A = 25°C. Low duty cycle pulse techniques are used during testing to maintain the junction temperature as close to ambient as possible.

^{8.} The fault-out pulse width t_{FOD} depends on the capacitance value of CFOD according to the following approximate equation: $t_{FOD} = 0.11 \times 10^6 \times \text{CFOD}$ (s).

^{9.} Values based on design and/or characterization.

Temperature of LVIC versus VTS Characteristics

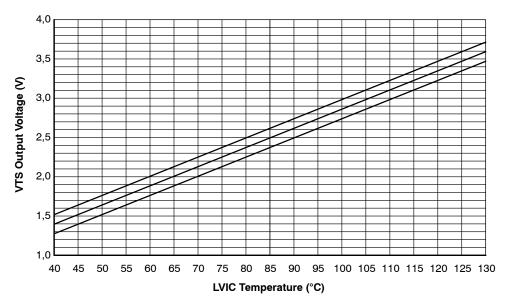


Figure 4. Temperature of LVIC versus VTS Characteristics

Table 1. THERMISTOR CHARACTERISTICS (INCLUDED ONLY IN NFAM3060L4BT)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Resistance	R ₂₅	Tc = 25°C	46.530	47	47.47	kΩ
Resistance	R ₁₂₅	Tc = 100°C	1.344	1.406	1.471	kΩ
B-Constant (25-50°C)	-	В	4009.5	4050	4090.5	К
Temperature range	-	-	-40	-	+125	°C

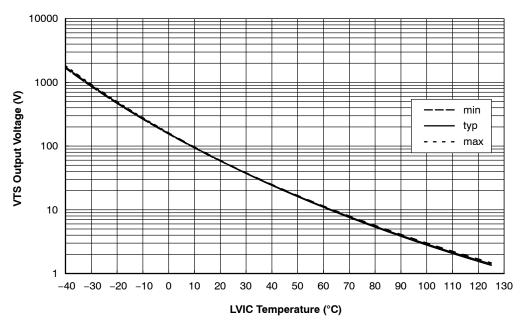


Figure 5. Thermistor Resistance versus Case Temperature



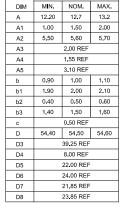


DIP39, 54.50x31.00x5.60, 1.78P **CASE MODGC ISSUE C**

DATE 05 MAY 2025

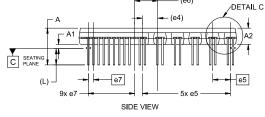
NOTES:

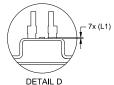
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. CONTROLLING DIMENSION: MILLIMETERS DIMENSION b and c APPLY TO THE PLATED LEADS AND ARE MEASURED BETWEEN 1.00 AND 2.00 FROM THE LEAD TIP
- POSITION OF THE LEAD IS DETERMINED AT THE BASE OF THE LEAD WHERE IT EXITS THE PACKAGE BODY
- AREA FOR 2D BAR CODE SHORTENED/CUT PINS ARE 2,5,8,11,14,17,19,29 AND 30
- DIMENSIONS "D" AND "E" DO NOT INCLUDE THE SIDE FLASH PROTRUSION WHICH IS \sim 0.12 FOR EACH SIDE

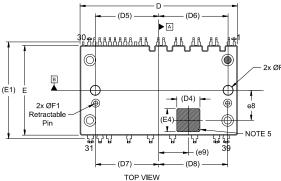


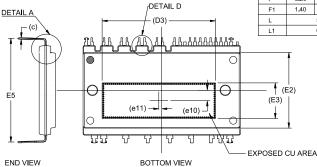
MILLIMETERS

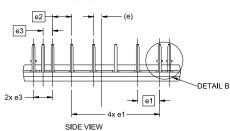
	-	LLIMETER			
DIM	MIN.	NOM.	MAX.		
Е	30.90	31.00	31.10		
E1	33.50 REF				
E2		26.14 REF			
E3		12.35 REF			
E4		8.00 REF			
E5	35.40	35.90	36.40		
е		2.81 REF			
e1		7.62 BSC			
e2	6,60 BSC				
е3	3,30 BSC				
e4	5.35 REF				
e5		6.10 BSC			
e6		8.02 REF			
e7		1.78 BSC			
e8		10.35 REF			
e9		10.25 REF			
e10		3.60 REF			
e11		1.00 REF			
e12	0.89 BSC				
F	3.20 3.30 3.40				
F1	1.40 1.50 1.60				
L	5.60 REF				
L1		0.10 REF			

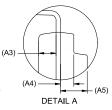


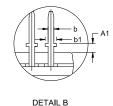


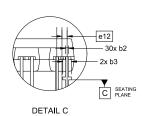




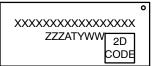








GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

= Assembly Lot Code

= Assembly & Test Location

= Year WW = Work Week *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " .", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON91300G	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED"		
DESCRIPTION:	DIP39, 54.50x31.00x5.60, 1	.78P	PAGE 1 OF 1	

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